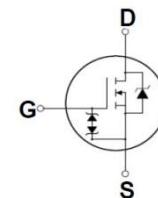
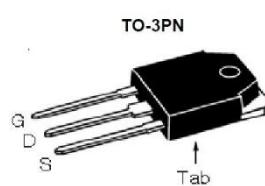


Features

- Low gate charge
- 100% avalanche tested
- Improved dv/dt capability
- RoHS compliant
- JEDEC Qualification

N-channel MOSFET		
BV_{DSS}	I_D	$R_{DS(on)MAX}$
900V	11A	<0.95Ω



Device	Package	Marking	Remark
TMAN11N90Z	TO-3PN	TMAN11N90Z	RoHS

Absolute Maximum Ratings

Parameter	Symbol	TMAN11N90Z	Unit
Drain-Source Voltage	V_{DS}	900	V
Gate-Source Voltage	V_{GS}	±30	V
Continuous Drain Current $T_C = 25\text{ °C}$	I_D	11	A
		8.5	A
Pulsed Drain Current (Note 1)	I_{DM}	44	A
Single Pulse Avalanche Energy (Note 2)	E_{AS}	360	mJ
Repetitive Avalanche Current (Note 1)	I_{AR}	11	A
Repetitive Avalanche Energy (Note 1)	E_{AR}	41.6	mJ
Power Dissipation $T_C = 25\text{ °C}$	P_D	416	W
		3.3	W/°C
Peak Diode Recovery dv/dt (Note 3)	dv/dt	4.5	V/ns
Operating Junction and Storage Temperature Range	T_J, T_{STG}	-55~150	°C
Maximum lead temperature for soldering purposes, 1/8" from case for 5 seconds	T_L	300	°C

* Limited only by maximum junction temperature

Thermal Characteristics

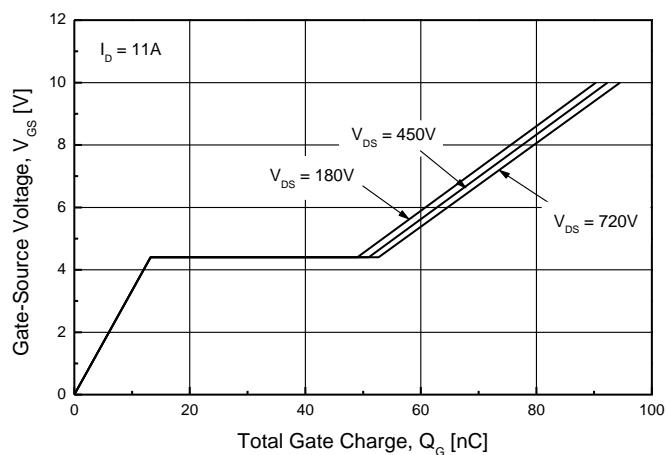
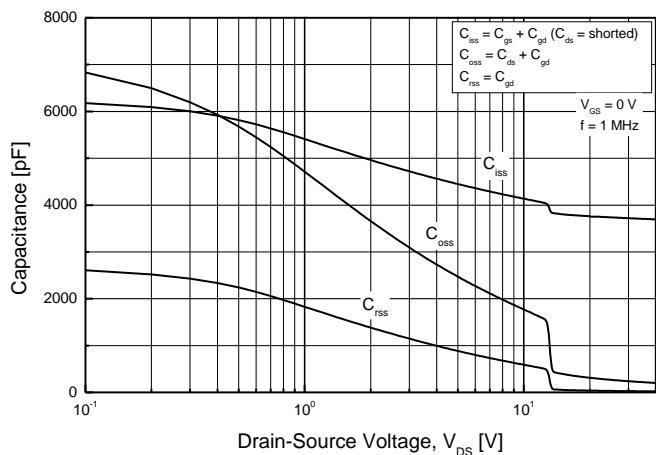
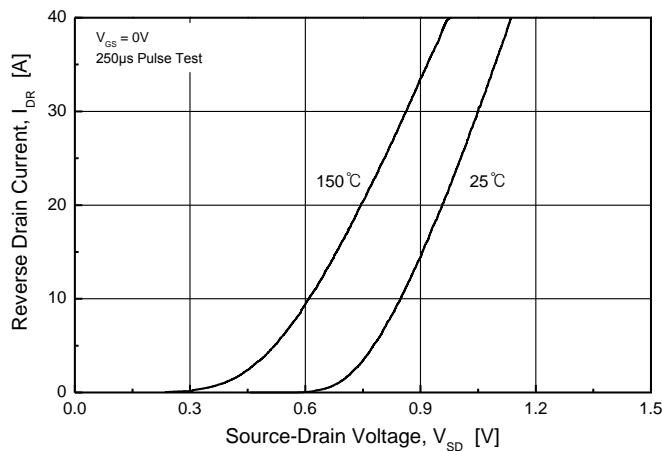
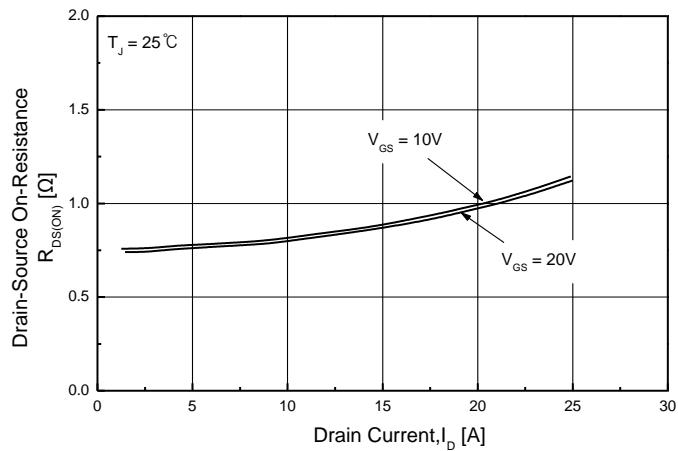
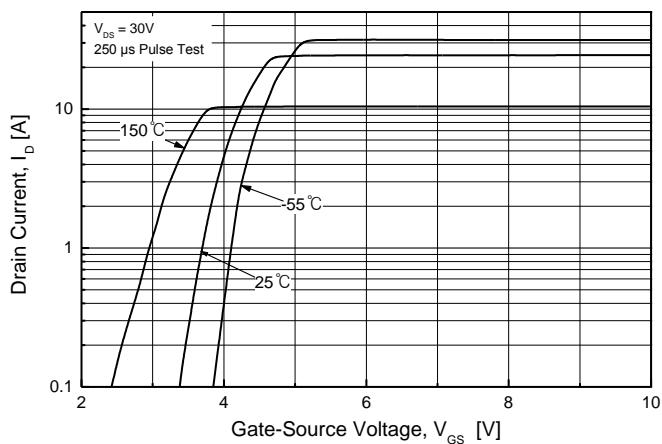
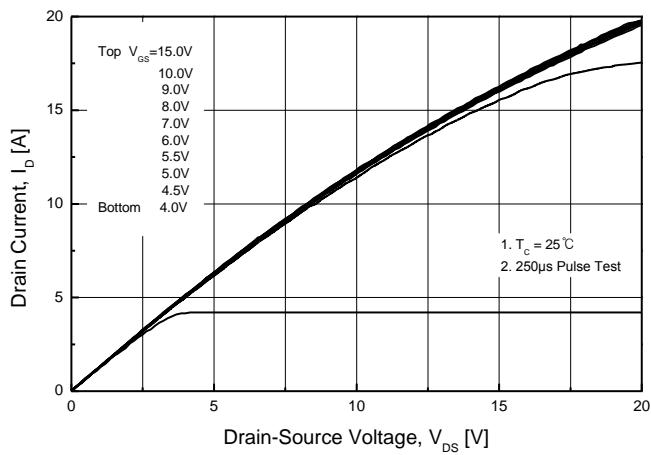
Parameter	Symbol	TMAN11N90Z	Unit
Maximum Thermal resistance, Junction-to-Case	$R_{\theta JC}$	0.3	°C/W
Maximum Thermal resistance, Junction-to-Ambient	$R_{\theta JA}$	62.5	°C/W

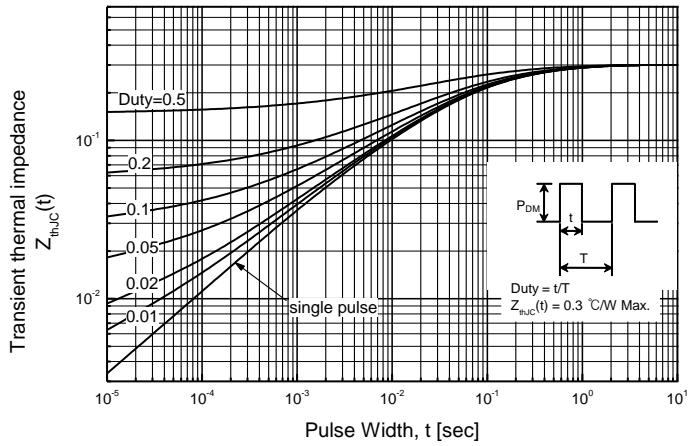
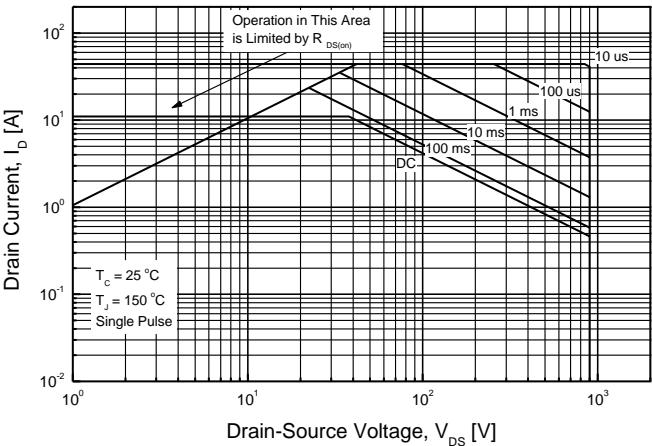
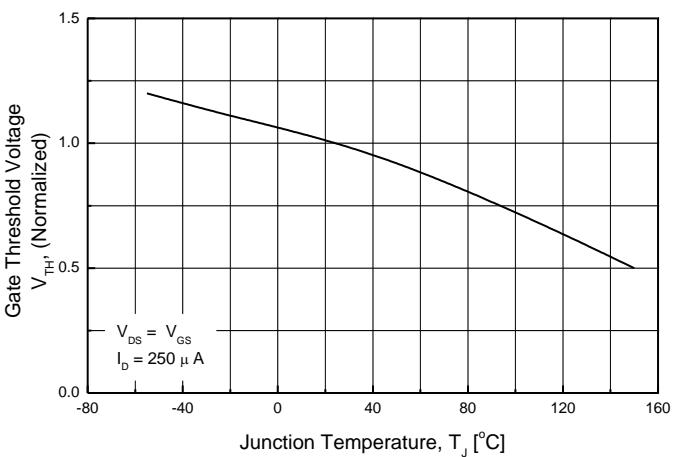
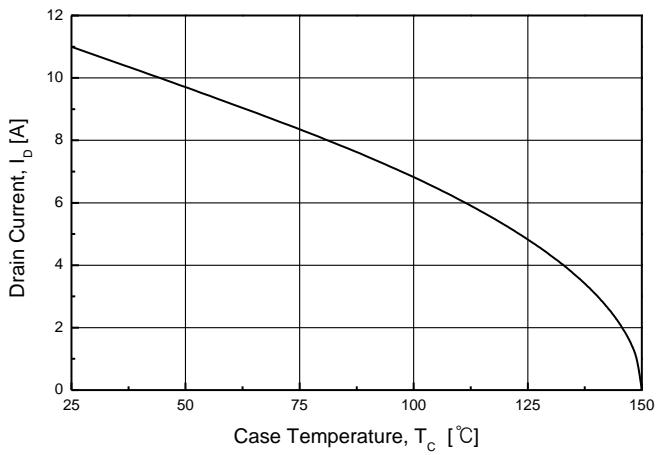
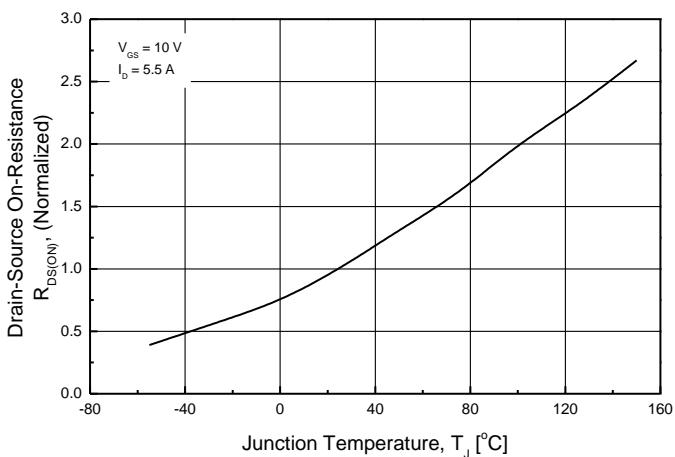
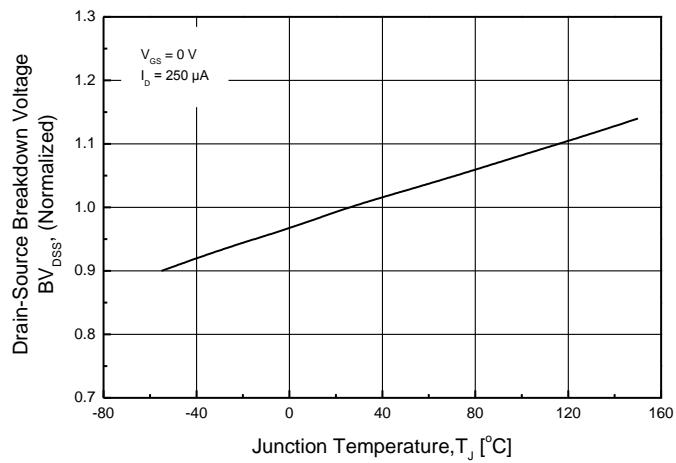
Electrical Characteristics : $T_c=25^\circ\text{C}$, unless otherwise noted

Parameter	Symbol	Test condition	Min	Typ	Max	Units
OFF						
Drain-Source Breakdown Voltage	BV_{DSS}	$V_{\text{GS}} = 0 \text{ V}, I_{\text{D}} = 250 \mu\text{A}$	900	--	--	V
Zero Gate Voltage Drain Current	I_{DSS}	$V_{\text{DS}} = 900 \text{ V}, V_{\text{GS}} = 0 \text{ V}$	--	--	1	μA
		$V_{\text{DS}} = 720 \text{ V}, T_c = 125^\circ\text{C}$	--	--	10	μA
Forward Gate-Source Leakage Current	I_{GSSF}	$V_{\text{GS}} = 30 \text{ V}, V_{\text{DS}} = 0 \text{ V}$	--	--	100	μA
Reverse Gate-Source Leakage Current	I_{GSSR}	$V_{\text{GS}} = -30 \text{ V}, V_{\text{DS}} = 0 \text{ V}$	--	--	-100	μA
ON						
Gate Threshold Voltage	$V_{\text{GS(th)}}$	$V_{\text{DS}} = V_{\text{GS}}, I_{\text{D}} = 250 \mu\text{A}$	2	--	4	V
Drain-Source On-Resistance	$R_{\text{DS(on)}}$	$V_{\text{GS}} = 10 \text{ V}, I_{\text{D}} = 5.5 \text{ A}$	--	0.75	0.95	Ω
Forward Transconductance ^(Note 4)	g_{FS}	$V_{\text{DS}} = 30 \text{ V}, I_{\text{D}} = 5.5 \text{ A}$	--	8	--	S
DYNAMIC						
Input Capacitance	C_{iss}	$V_{\text{DS}} = 25 \text{ V}, V_{\text{GS}} = 0 \text{ V}, f = 1.0 \text{ MHz}$	--	3737	--	pF
Output Capacitance	C_{oss}		--	267	--	pF
Reverse Transfer Capacitance	C_{rss}		--	32	--	pF
SWITCHING						
Turn-On Delay Time ^(Note 4,5)	$t_{\text{d(on)}}$	$V_{\text{DD}} = 450 \text{ V}, I_{\text{D}} = 11 \text{ A}, R_{\text{G}} = 25 \Omega$	--	59	--	ns
Turn-On Rise Time ^(Note 4,5)	t_{r}		--	62	--	ns
Turn-Off Delay Time ^(Note 4,5)	$t_{\text{d(off)}}$		--	408	--	ns
Turn-Off Fall Time ^(Note 4,5)	t_{f}		--	83	--	ns
Total Gate Charge ^(Note 4,5)	Q_{g}	$V_{\text{DS}} = 720 \text{ V}, I_{\text{D}} = 11 \text{ A}, V_{\text{GS}} = 10 \text{ V}$	--	95	--	nC
Gate-Source Charge ^(Note 4,5)	Q_{gs}		--	13	--	nC
Gate-Drain Charge ^(Note 4,5)	Q_{gd}		--	40	--	nC
SOURCE DRAIN DIODE						
Maximum Continuous Drain-Source Diode Forward Current	I_{S}	---	--	--	11	A
Maximum Pulsed Drain-Source Diode Forward Current	I_{SM}	---	--	--	44	A
Drain-Source Diode Forward Voltage	V_{SD}	$V_{\text{GS}} = 0 \text{ V}, I_{\text{S}} = 11 \text{ A}$	--	--	1.5	V
Reverse Recovery Time ^(Note 4)	t_{rr}	$V_{\text{GS}} = 0 \text{ V}, I_{\text{S}} = 11 \text{ A}$ $dI_{\text{F}} / dt = 100 \text{ A}/\mu\text{s}$	--	513	--	ns
Reverse Recovery Charge ^(Note 4)	Q_{rr}		--	6	--	μC

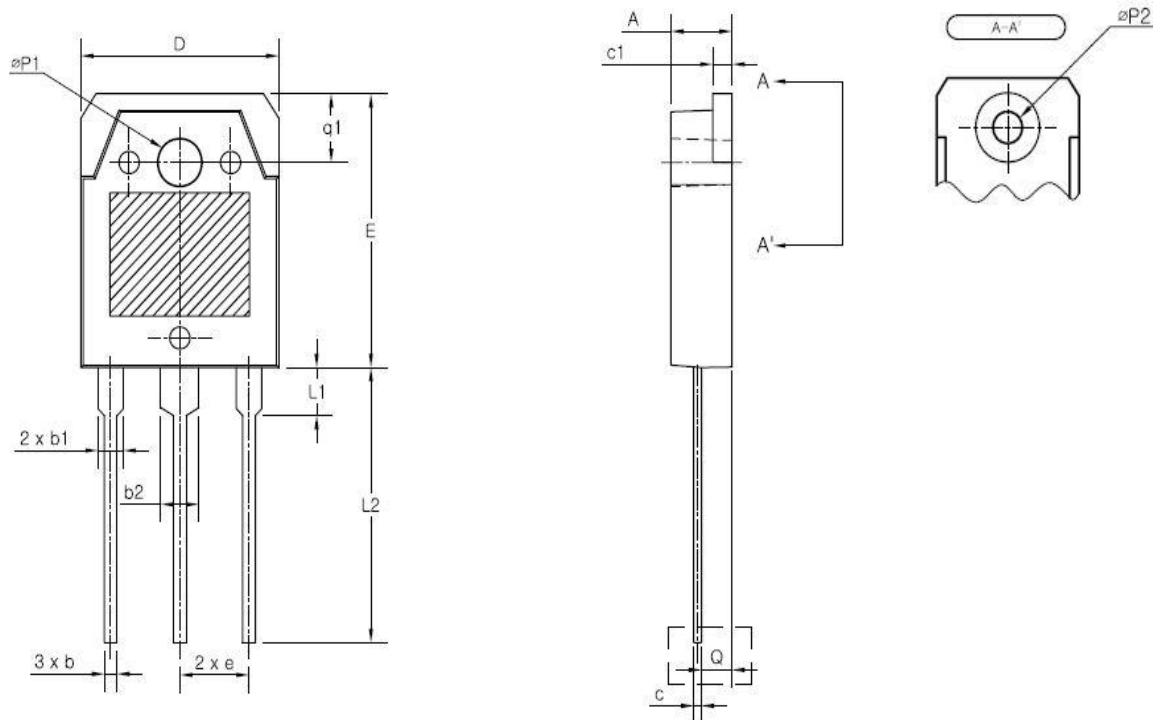
Note :

1. Repeated rating : Pulse width limited by safe operating area
2. $L=5.6\text{mH}$, $I_{\text{AS}} = 11\text{A}$, $V_{\text{DD}} = 50\text{V}$, $R_{\text{G}} = 25\Omega$, Starting $T_j = 25^\circ\text{C}$
3. $I_{\text{SD}} \leq 11\text{A}$, $di/dt \leq 200\text{A}/\mu\text{s}$, $V_{\text{DD}} \leq \text{BV}_{\text{DS}}$, Starting $T_j = 25^\circ\text{C}$
4. Pulse Test : Pulse width $\leq 300\mu\text{s}$, Duty Cycle $\leq 2\%$
5. Essentially Independent of Operating Temperature Typical Characteristics





TO-3PN MECHANICAL DATA



SYMBOL	MIN	NOM	MAX
A	4.60	4.80	5.00
b	0.80	1.00	1.20
b1	1.80	2.00	2.20
b2	2.80	3.00	3.20
c	0.55	0.60	0.75
c1	1.45	1.50	1.65
D	15.40	15.60	15.80
E	19.70	19.90	20.10
e	5.15	5.45	5.75
L1	3.30	3.50	3.70
L2	19.80	20.00	20.20
øP1	3.30	3.40	3.50
øP2	(3.20)		
Q	2.20	2.40	2.60
q1	4.80	5.00	5.20